

# **MS9N90**

### N-Channel 900V MOSFET

### Description

The MS9N90 is a N-channel enhancement-mode MOSFET, providing the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness. The TO-220AB package is universally preferred for all commercial-industrial applications

#### **Features**

- R<sub>DS(on)</sub> (Max 1.4 Ω)@V<sub>GS</sub>=10V •
- Gate Charge (Typical 47nC) •
- Improved dv/dt Capability, High Ruggedness •
- 100% Avalanche Tested .
- Maximum Junction Temperature Range (150°C) •
- RoHS compliant package •

#### Application

- Adapter ٠
- Switching Mode Power Supply

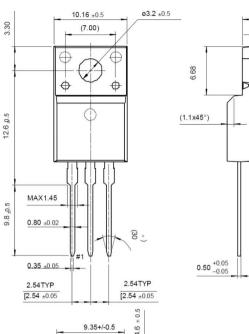
Package type : TO-220AB

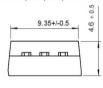
#### **Packing & Order Information**

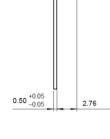
50/Tube ; 1,000/Box







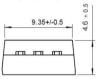




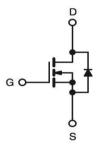
2.54 +/-0.5

(0.70)

15.80 40.5



Graphic symbol



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise specified)						
Symbol	Parameter	Value	Unit			
V <sub>DSS</sub>	Drain-Source Voltage	900	V			
V <sub>GS</sub>	Gate-Source Voltage	±30	V			
I.	Drain Current -Continuous (TC=25°C)	9	А			
ID	Drain Current -Continuous (TC=100°C)	6	А			
IDM	Drain Current -Pulsed	36	А			
E <sub>AS</sub>	Single Pulsed Avalanche Energy	900	mJ			
E <sub>AR</sub>	Repetitive Avalanche Energy	28	mJ			
dV/dt	Peak Diode Recovery dV/dt	4.0	V/ns			
P <sub>D</sub>	Power Dissipation (TC=25°C)	280	W			
	- Derate above 25C	2.22	W/°C			
$T_J/T_{STG}$	Operating Junction and Storage Temperature	-55 to +150	°C			

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Absolute Maximum Ratings (Tc=25°C unless otherwise specified)						
Symbol	Parameter	Value	Unit			
T <sub>L</sub>	Maximum lead temperature for soldering purposes,	300	°C			
	1/8" from case for 5 seconds	500	C			

• Drain current limited by maximum junction temperature

Thermal Resistance Characteristics						
Symbol	Parameter	Typ.	Max.	Units		
Rejc	Junction-to-Case		0.75	0 <b>C (W</b>		
Reja	Junction-to-Ambient		62.5	°C/W		

On Characteristics							
Parameter	Test Conditions	Min	Тур.	Max.	Units		
Gate Threshold Voltage	$V_{DS}=V_{GS},I_D\!=\!250\mu A$	3.0		5.0	v		
Static Drain-Source	$V_{GS} = 10 \ V \ , \ I_D = 4.5 \ A$		1.10	1.40	Ω		
	Parameter   Gate Threshold Voltage	ParameterTest ConditionsGate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$ Static Drain-Source $V_{GS} = 10 \text{ V}$ , $I_D = 4.5 \text{ A}$	ParameterTest ConditionsMinGate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$ 3.0Static Drain-Source $V_{GS} = 10 \text{ V}$ , $I_D = 4.5 \text{ A}$	ParameterTest ConditionsMinTyp.Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$ 3.0Static Drain-Source $V_{GS} = 10 \text{ V}$ , $I_D = 4.5 \text{ A}$ 1.10	ParameterTest ConditionsMinTyp.Max.Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$ 3.05.0Static Drain-Source $V_{GS} = 10 \text{ V}$ , $I_D = 4.5 \text{ A}$ 1.101.40		

Off Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}=0~V~,~I_D=250\mu A$	900			v
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu A$ , Referenced to $25^{\circ}C$		1.05		V/°C
I <sub>DS S</sub>	Zero Gate Voltage Drain Current				10 100	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{DS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	μA
Igssr	Gate-Body Leakage Current, Reverse	$V_{DS} = -30 V, V_{DS} = 0 V$			-100	nA

Dynamic Characteristics							
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
CISS	Input Capacitance	$ V_{DS} = 25 V, V_{GS} = 0 V, $ - f = 1.0MHz		2200		pF	
Coss	Output Capacitance			180		pF	
C <sub>RSS</sub>	Reverse Transfer Capacitance			15		pF	



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Dynamic Characteristics							
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
t <sub>d(on)</sub>	Turn-On Time	$V_{DS} = 450 \text{ V}, \text{ I}_D = 9 \text{ A},$ $R_G = 25 \Omega$		60		ns	
tr	Turn-On Time			130		ns	
t <sub>d(off)</sub>	Turn-Off De la y Time			110		ns	
tf	Turn-Off Fall Time			80		ns	
Qg	Total Gate Charge	$V_{DS} = 720 V, I_D = 10 A,$ $V_{GS} = 9 V$		47		nC	
$Q_{gs}$	Gate-Source Charge			15		nC	
$\mathbf{Q}_{\mathrm{gd}}$	Gate-Drain Charge			20		nC	

Source-Drain Diode Maximum Ratings and Characteristics								
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units		
Is	Continuous Source-Drain Diode Forward Current9.0							
I <sub>SM</sub>	ISM Pulsed Source-Drain Diode Forwa			35	A			
Vsd	Source-Drain Diode Forward Voltage	$I_S = 9 A$ , $V_{GS} = 0 V$			1.4	v		
trr	Reverse Recovery Time	$I_S = 9 A$ , $V_{GS} = 0 V$		550		ns		
Qm	Reverse Recovery Charge	diF/dt=100A/µs		6.5		μC		

Notes:

1. Repeativity rating : pulse width limited by junction temperature

2. L = 21mH, I<sub>AS</sub> =9.0A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25 $\Omega$ , Starting TJ = 25°C

3. I<sub>SD</sub>  $\leq$  9.0A, di/dt  $\leq$  200A/us, VDD  $\leq$  BVDSS, Starting TJ = 25°C

4. Pulse Test : Pulse Width  $\leq$  300us, Duty Cycle  $\leq$  2%

5. Essentially independent of operating temperature.



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